

**AMENDMENT FEE TRANSMITTAL LETTER**

MAIL STOP RCE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Appl. No.: 10/525,996 Filing Date: 2005-02-28  
Examiner: Cuong Q. Nguyen Group Art Unit: 2811  
Invention: Semiconductor Wafer Protection Structure and Laminated Protective Sheet for Use Therein

Transmitted herewith is an amendment in the above-identified application.

☐ Small entity status of this application has been averred.  
☒ Request for Continued Examination.  
☒ Petition for Extension of Time.  
☐ The fee has been calculated as shown below:

No. of Claims After Amendment	Highest No. Previously Paid For	Present Extra		Small Entity Rate	Non-Small Entity Rate	Charge
Total <u>5</u>	<u>20</u>	<u>0</u>	X	\$ 25.00	X \$ 50.00	\$ <u>-0-</u>
Indep. <u>2</u>	<u>3</u>	<u>0</u>	X	\$105.00	X \$210.00	\$ <u>-0-</u>
First Presentation of Multiple Dep. Claim				+ \$185.00	+ \$370.00	\$ <u>-0-</u>
Total Additional Fee						\$ <u>-0-</u>

☒ Payment in the amount of \$ 1,740 is authorized by credit card.  
☒ The Commissioner is hereby authorized to charge payment of any additional fees required to Deposit Account No. 23-0650. Please refund any overpayment to Deposit Account No. 23-0650.  
☒ Any additional filing fees required under 37 CFR 1.16.  
☒ Any patent application processing fees under 37 CFR 1.17.

November 19, 2007  
Date

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I hereby certify that this correspondence is being electronically submitted to the United States Patent and Trademark Office on the date set forth below.

Dianne E. Kimak  
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Signature

11/19/2007  
Date